

RoHS Compliant Product
A suffix of "-C" specifies halogen & lead-free

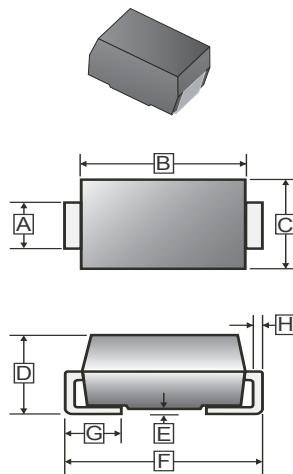
FEATURES

- High Current Capability
- Extremely Low Thermal Resistance
- For Surface Mount Application
- Higher Temp Soldering : 250°C for 10 Seconds at Terminals
- Low Reverse Current

MECHANICAL DATA

- Case: Molded Plastic
- Epoxy: UL 94V-0 Rate Flame Retardant
- Lead: Axial Leads, Solderable per MIL-STD-202 method 208 Guaranteed
- Polarity: Color Band Denotes Cathode End
- Mounting Position: Any

SMB



PACKAGE INFORMATION

| Package | MPQ | Leader Size |
|---------|-----|-------------|
| SMB | 3K | 13 inch |

| REF. | Millimeter | | REF. | Millimeter | |
|------|------------|------|------|------------|-------|
| | Min. | Max. | | Min. | Max. |
| A | 1.91 | 2.20 | E | - | 0.203 |
| B | 4.06 | 4.70 | F | 5.08 | 5.59 |
| C | 3.30 | 3.94 | G | 0.76 | 1.52 |
| D | 2.13 | 2.44 | H | 0.15 | 0.305 |

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

(Rating 25°C ambient temperature unless otherwise specified. Single phase half wave, 60Hz, resistive or inductive load.
For capacitive load, de-rate current by 20%).

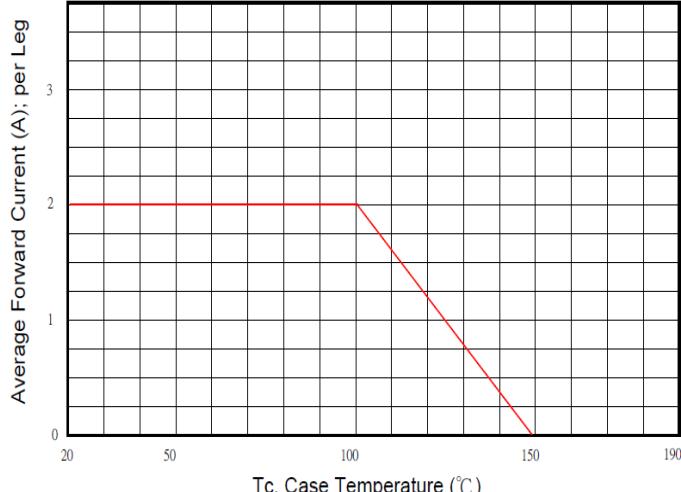
| Parameter | Symbol | Rating | Unit |
|---|-----------------------------|---------|----------------|
| Peak Repetitive Peak reverse voltage | V_{RRM} | 200 | V |
| Working Peak Reverse Voltage | V_{RWM} | 200 | V |
| Maximum DC Blocking Voltage | V_R | 200 | V |
| Average Forward Current @ $T_J=25^\circ C$ | $I_{F(AV)}$ | 2 | A |
| Peak Forward Current @ 8.3 ms Half Sine | I_{FSM} | 60 | A |
| Maximum Instantaneous Forward Voltage | $I_{FM}=2A, T_A=25^\circ C$ | 0.85 | V |
| | | 0.75 | |
| | | 0.68 | |
| Maximum DC Reverse Current At Rated DC Blocking Voltage | $T_J=25^\circ C$ | 10 | μA |
| | | 50 | |
| Typical Junction Capacitance ¹ | C_J | 40 | pF |
| Typical Thermal Resistance ² | $R_{\theta JA}$ | 50 | $^\circ C / W$ |
| Typical Thermal Resistance ³ | $R_{\theta JC}$ | 25 | $^\circ C / W$ |
| Voltage Rate of Change (Rated V_R) | dv/dt | 10000 | $V / \mu s$ |
| Operating Temperature Range | T_J | -50~150 | $^\circ C$ |
| Storage temperature | T_{STG} | -65~150 | $^\circ C$ |

Notes:

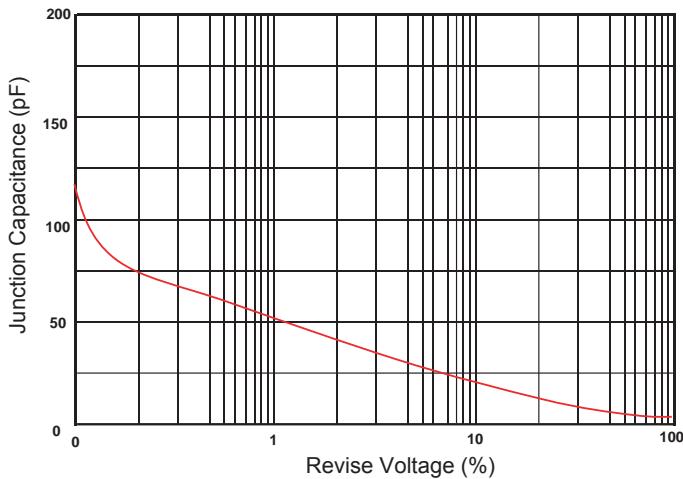
1. Measured at 1MHz and applied reverse voltage of 5.0V D.C.
2. Thermal Resistance Junction to Ambient.
3. Thermal Resistance Junction to Case.

RATINGS AND CHARACTERISTIC CURVES

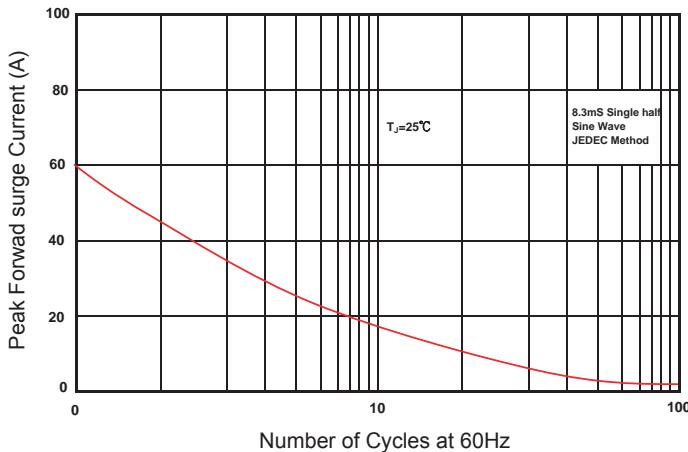
Typical Forward Current Derating Curve



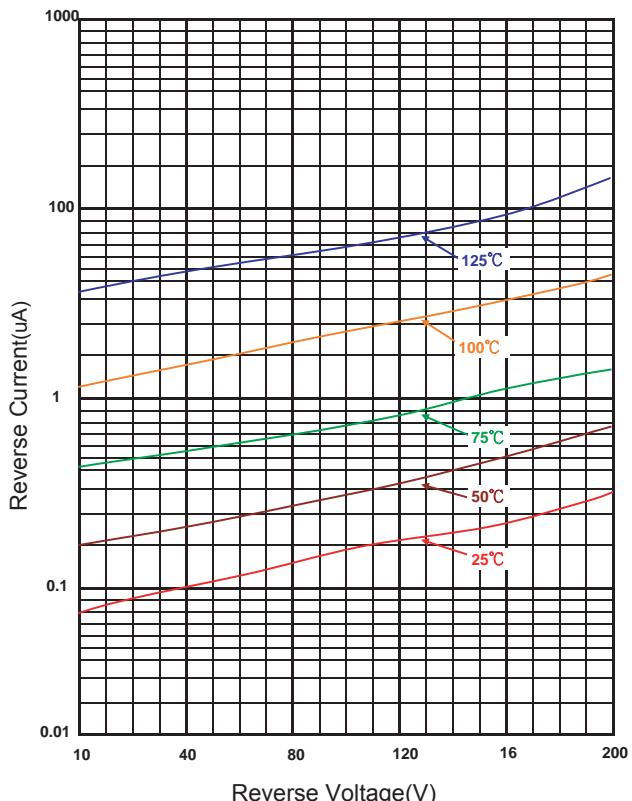
Typical Junction Capacitance



Maximum Non-Repetitive Forward Surge Current



Typical Reverse Characteristic



Typical Forward Characteristic

